

ABSTRACT OF DISCLOSURE

An electronic device, comprising: a substrate of insulating resin having at least a pair of interior terminal portions for connection upon an upper surface thereof; an electronic element
5 mounted on the terminal portions on the upper surface of said substrate, having at least a pair of electrode terminals thereof; a frame member of insulating resin, bonded on the upper surface of said substrate, and having a cavity formed for storing said electronic element therein; and a cover member of insulating
10 material, for hermetically sealing over the cavity of said frame member, in which said electronic element is stored, wherein electrodes are formed at or in vicinity of positions of the terminals of said electronic element stored within said cavity, for
15 electrically conducting said interior terminal portions for connection to an outside, or wherein roughened surfaces are formed on metal electrode portions, which are formed on the upper surface of said substrate for electrically conducting said interior terminal portions to said exterior terminal portions, where said frame member is bonded thereupon.